



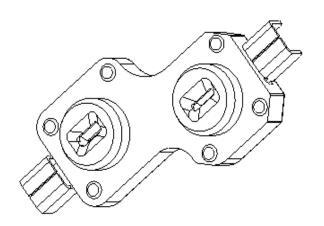


**Document Number:** 

KH-PS-1702-35

# 产品规格书

# Product Specification



<u>P/N:</u>	<u>P/N:</u> Title:					
CPG135001S30			1350Connector			
Rev.	ECN	Release and Revision  Description:	PreparedBy/Date:	Checked By/Date:	Approved By/Date:	
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#### 1. Scope/范围:

This Product Specification covers the requirement of Mechanical keyboard Connector switch on product performance, test methods and quality assurance provisions.

本规格书内容涵盖机械键盘连接器产品的要求,包括性能指标、测试方法及质量保证方面等。

#### 2. Product Application/产品应用:

Mainly applied on computer keyboards, cash registers equipment and Man-Machine interface.

主要适用于电脑, 收银机, 工业设备和人机界面

#### 3. Technology Parameters/技术参数

Ambient Humidity 工作湿度:

Operating Temperature Range 使用温度范围:

Storage Temperature Range 保存温度范围:

Normal Condition:

Ambient temperature 环境温度:

Relative humidity 相对湿度:

Air pressure 气压:

Contact Resistance 接触阻抗:

Solder Ability 可焊性:

Withstand Soldering Temperature 耐焊接热:

45~95% R.H.:

-10℃~+60℃:

-20℃~+70℃:

20±2°C

85% ± 5% R.H.;

86~101KPa:

100 m  $\Omega$  Max;

 $260\pm5^{\circ}$ ,  $3\pm0.5$ s;

 $260\pm5^{\circ}\text{C,}5\pm0.5\text{s};$ 

#### 4. Ratings/额定性能要求

RatingVoltare 额定电压:

Rating Current 额定电流

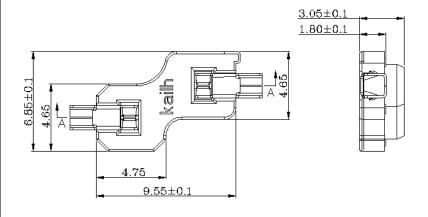
InsulationResistance 绝缘电阻:

Withstand Voltage 耐电压:

Mechanical Life 机械寿命:

5. Profile Dimensions /外形尺寸

12V AC/DC max; 2V DC min 10mA AC/DC max; 10uA DC min ≥100MΩ/DC 500V; AC 100V 1 Minute; 100Cycles .





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#### 6. Electrical Performance/电气性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
6.1	Contact Resistance 接触电阻	Static load: (Operation force)x2, which is applied on the center of Switch stem. 静态负载: 动作力的 2 倍,施加在手柄中心. 100mΩ Ma Measurement tool: Contact resistance Meter. 测量工具: 微电流接触电阻计(1KHz, 20mV,5~50mA)	
6.2	Insulation Resistance 绝缘电阻	Apply a Voltage of DC 500 V for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 500V DC 电压 1 分钟,按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	100MΩ Min 100 兆欧以上
6.3	Dielectric withstanding voltage 耐电压	Apply a Voltage of AC 100 V (50~60Hz) for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 100V AC 电压 1 分钟, 按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	No evidence of breakdown 无瞬断、击穿等破坏.



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#### 7. Mechanical Performance/机械性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求			
7.1	Mating force 插入力	At 16in/minute.actuation speed	Mating force 插入力3KG max			
7.2	Unmating force 拔出力	At 16in/minute.actuation speed	Unmating force 拔出力 200gf min			
7.3	Shock 机械冲击	Measured by according to the below condition: (1) Acceleration: 80g 加速度 (2) Cycles of test:3 cycles each in 6 directions, for a total of 18 cycles. 试验次数: 每个方向 3 次, 6 个方向共 18 次.	Appearance: No abnormality. 外观无异常			
7.4	Life Test 寿命测试	(1) without load 无负载 (2) Mating force: Maximum value of operation force. 插入力:操作力规格值的上限. (3) Cycles: 100 Min 操作次数: 100 次以上	Contact resistance: 1000 m Ω Max 接触电阻: 1000 毫欧以下 Bouncing: 10ms Max			



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#### 8. Environmental Performance/环境性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
8.1	Cold test 耐寒性	(1) Temperature: - 20±2℃ 温度: - 20±2℃ (2) Duration of test: 48h 持续时间: 48 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test: 1h 试验后的放置条件: 1 小时	Contact resistance: 200m Ω Max 接触电阻 200m Ω以下
8.2	Heat test 耐热性	(1) Temperature: 70±2℃ 温度: 70±2℃ (2) Duration of test: 48h 持续时间: 48 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test: 1h 试验后的放置条件: 1 小时	Contact resistance: 200m Ω Max Shall meet: No. 6.2 接触电阻 200m Ω以下 满足: No. 6.2
8.3	Temperature cycle 温度循环	(1) Test cycles: 5 cycles 试验周期: 5 个周期 (2) Standard condition after test:1h 试验后的放置条件: 1 小时  Temperature Duration of test 持续时间 20±5℃ 1h 1 cycle -次循环 20±5℃ 1h 20±5℃ 1h 70±5℃ 1h	Contact resistance: 200m Ω Max Shall meet: No. 6.2 接触电阻 200m Ω以下 满足: No. 6.2
8.4	Soldering heat test 耐焊接热	Soldering area: T/2 of PWB thickness. (PWB: T=1.6mm) 焊接面积: 印刷基板的 1/2 厚度处 Soldering temperature: 260±5℃ Soldering time: 5±0.5s 焊接温度: 260±5℃ 焊接时间: 5±0.5 秒	Appearance: No abnormality. 外观无异常



# 凱華電子

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Ka			CPG 13500 1350	14110	1702-33		
8.5	Solderability可焊性	1. Hand soldering 手工焊接: Please practice according to below condition:  (1) Soldering Temperature: 350±5℃ 焊接温度: 350±5℃ (2) Continual soldering time: 3±0.5s 连续焊接时间: 3±0.5 秒  (3) Capacity of soldering iron: ≤20w 电烙铁功率: 20 瓦以下  2. AutomaticReflow soldering 自动回流焊接: For the product of SMT, according to below condition:  SMT 回流焊温度曲线图  AUS MAX Peak temperature  WHERE TO TO THE		At least 95% of surface area of immersed portion shall be covered by solder. 侵焊面积大于 95%以上.			
8.6	(1) Temperature: 60±2℃ 温度: 60±2℃ 温度: 60±2℃ (2) relative humidity: 90~95% R.H. 相对湿度:90~95% R.H. (3) Duration of test: 48h 持续时间: 48 小时 (4) Take off a drop water 去掉水珠 (5) Standard conditions after test: 1h 试验后的放置条件: 1 小时			Contact re 200m Ω I Shall mee No. 6.2 接触电阻 满足: No. 6.2	Max et :		



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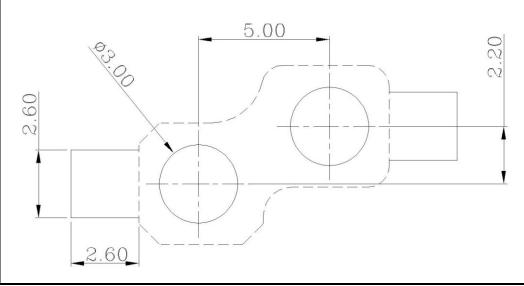
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8.7	Salt Spray 盐雾测试	Apply the following environment to test: 根据下列条件进行测试: (1) Temperature: 35±5℃ 温度: 35±5℃; (2) Salt water density: 5±1% 盐水浓度: 5±1%; (3) Duration: 12 hours 持续时间: 12 小时; (4) After test, the salt deposit shall be removed by running water. 实验后将盐沉积物用水冲掉	Appearance: No corrosion spot, no crack, no base plate naked. 外观: 无腐蚀点, 无裂纹, 无裸露基材.  Contact Resistance: 200 m Ω Max 接触电阻: 200 毫欧以下
8.8	Withstand K2S 硫化测试	Apply the following environment to test: 根据下列条件进行测试 (1) Temperature: 35±5℃温度: 35±5℃ (2) K <sub>2</sub> S Density: 2%; 硫化钾浓度: 2% (3) Duration: 2 minute. 持续时间: 2 分钟	Appearance: No corrosion spot, no crack, no base plate naked. 外观: 无腐蚀点, 无裂纹, 无裸露基材.  Contact Resistance: 1000 m Ω Max 接触电阻: 1000 毫欧以下

#### 9. Recommended PCB Layout 推荐的 PCB 安装焊盘规格

(Top View) (Single face board T=1.6mm)







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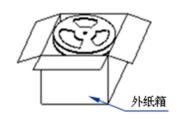
#### 10.Packaging 包装

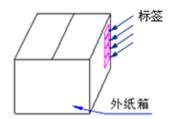
Packaging type: 13Tray, 26000Pcs/Carton.

包装方式:13/盘, 26000Pcs/箱.



卷盘





#### 11.Precaution 注意事项

11.1 Soldering condition 回流焊条件

ITEM		CONDITION	
项目		条件	
	Heating zone	Speed<2°C/S, Preheating time15 S Max,temperture150°C	
	升温区	速度<2°C/S, 预热时间 15 S 最多,温度 150°C	
Preheating zone	Heatpreservati	Speed1. 2∼3. 5°C / S,Preheating time120 S Max,temperture180°C	
预热区	on area	速度 1. 2~3. 5°C/S, 预热时间 120 S 最多,温度 180°C	
1X/W.E.	保温区	是及1.2 0.0 0 / 5 ,	
	Fast heating zone	Speed3. 5~4. 5°C/S, Preheating time140 S Max,temperture230°C	
	快速升温区	速度 3.5~4.5℃/S, 预热时间 140 S 最多,温度 230℃	
Weld area		Welding time 40 S Max ,welding temperature peak value, 3 sec Max.	
焊接区		焊接时间 40 S 最多, 焊接温度峰值 260℃最大,3 S 最多	
Area of flux		1/2 Max of PWB Thickness	
助焊剂面积		印刷基板厚度的 1/2 以内	
Temperature of se	older	260±5℃	
焊锡温度		260±5℃	
Number of solder	ring	2time Max (But should down heat of the first soldering)	
焊接次数		2次以内	
Printed wiring boa	ard	Single side copper-clad laminates	
印刷基板		单面铜箔	

- (1) After reflow, be careful not to clean switches with solvent 回流焊后,注意不要用溶剂清洗.
- (2) Under the condition of using soldering iron, soldering temperature shall be 350℃ max within 3 sec. 在使用铬铁的情况下,焊锡温度应在350℃以下,焊接时间3秒以内.



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#### 11.2 Notes 注意点

- (1) Please be cautious not to give excessive static load connector. 注意不要施加超负荷的压力或晃动连接器.
- (2) Connectorbe careful not to stack up P. W. B. after switches were soldered. 连接器焊接以后,印刷基板注意不要叠放.
- (3) Preservation under high temperature and high humidity or corrosive gas should be avoided Especially. When you need to preserve for a long period, do not open the carton. 保管时尤其应注意避开高湿高温和有腐蚀性气体的环境.如需长时间保存,请不要打开包装箱.
- (4) The standard storage period is 3 months, with maximum up to 6months, preferably to be used as soon as possible. After opening the package, you should put the remaining switches in a plastic bag to prevent from damp and corrosive gas.
  - 保存标准为3个月,限度为6个月以内,请尽早使用. 打开包装后,有剩余品时,应将剩余部分以胶袋包装好以同外界隔离,请进行合适的防湿,防腐蚀气体等处理后进行保管.
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